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60 V, 1 A, Low V_{CE(sat)} NPN Transistors

ON Semiconductor's e^2 PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and LED lightning, power management...etc. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- NSV60101DMTWTBG Wettable Flanks Device
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit
Collector–Emitter Voltage	V _{CEO}	60	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V _{EBO}	6	Vdc
Collector Current – Continuous	I _C	1	Α
Collector Current – Peak	I _{CM}	2	Α

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction–to–Ambient (Notes 1 and 2)	$R_{\theta JA}$	55	°C/W
Total Power Dissipation per Package @ $T_A = 25^{\circ}C$ (Note 2)	P _D	2.27	W
Thermal Resistance Junction-to-Ambient (Note 3)	$R_{\theta JA}$	69	°C/W
Power Dissipation per Transistor @ T _A = 25°C (Note 3)	P _D	1.8	W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

- Per JESD51-7 with 100 mm² pad area and 2 oz. Cu (Dual Operation).
- 2. P_D per Transistor when both are turned on is one half of Total P_D or 1.13 Watts.
- 3. Per JESD51-7 with 100 mm² pad area and 2 oz. Cu (Single-Operation).



ON Semiconductor®

www.onsemi.com

60 Volt, 1 Amp NPN Low $V_{CE(sat)}$ Transistors

MARKING DIAGRAM



WDFN6 CASE 506AN



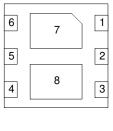
AN = Specific Device Code

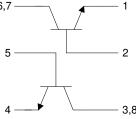
M = Date Code

■ = Pb–Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS





ORDERING INFORMATION

Device	Package	Shipping [†]
NSS60101DMTTBG	WDFN6 (Pb-Free)	3000/Tape & Reel
NSV60101DMTWTBG	WDFN6 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

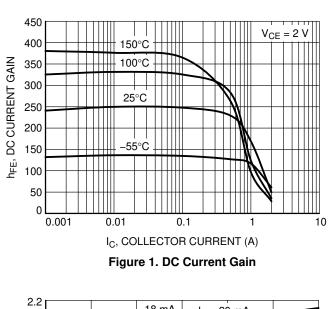
Table 1. ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•	•	•
Collector–Emitter Breakdown Voltage (I _C = 10 mA, I _B = 0)	$V_{(BR)CEO}$	60			V
Collector-Base Breakdown Voltage (Ic = 0.1 mA, I _E = 0)	V _{(BR)CBO}	80			V
Emitter–Base Breakdown Voltage ($I_E = 0.1 \text{ mA}, I_C = 0$)	$V_{(BR)EBO}$	6			V
Collector Cutoff Current (V _{CB} = 60 V, I _E = 0)	I _{CBO}			100	nA
Emitter Cutoff Current (V _{BE} = 5.0 V)	I _{EBO}			100	nA
ON CHARACTERISTICS					
DC Current Gain (Note 4) $ (I_{C} = 100 \text{ mA}, V_{CE} = 2.0 \text{ V}) $ $ (I_{C} = 500 \text{ mA}, V_{CE} = 2.0 \text{ V}) $ $ (I_{C} = 1 \text{ A}, V_{CE} = 2.0 \text{ V}) $ $ (I_{C} = 2 \text{ A}, V_{CE} = 2.0 \text{ V}) $	h _{FE}	150 120 90 35	250 240 180 55		
Collector–Emitter Saturation Voltage (Note 4) ($I_C = 500$ mA, $I_B = 50$ mA) ($I_C = 1$ A, $I_B = 50$ mA) ($I_C = 1$ A, $I_B = 100$ mA)	V _{CE(sat)}		0.063 0.130 0.115	0.100 0.200 0.180	V
Base – Emitter Saturation Voltage (Note 4) $ (I_C = 500 \text{ mA}, I_B = 50 \text{ mA}) $ $ (I_C = 1 \text{ A}, I_B = 50 \text{ mA}) $ $ (I_C = 1 \text{ A}, I_B = 100 \text{ mA}) $	V _{BE(sat)}			1.0 1.0 1.1	V
Base–Emitter Turn–on Voltage (Note 4) (I _C = 500 mA, V _{CE} = 2 V)	V _{BE(on)}			0.9	V
DYNAMIC CHARACTERISTICS			•	•	
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)	C _{obo}		10		pF
Cutoff Frequency ($I_C = 50 \text{ mA}$, $V_{CE} = 2.0 \text{ V}$, $f = 100 \text{ MHz}$)	f _T		180		MHz
SWITCHING TIMES					
Delay Time ($V_{CC} = 10 \text{ V}, I_C = 0.5 \text{ A}, I_{B1} = 25 \text{ mA}, I_{B2} = -25 \text{ mA}$)	t _d		13		ns
Rise Time ($V_{CC} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, I_{B1} = 25 \text{ mA}, I_{B2} = -25 \text{ mA}$)	t _r		18		ns
Storage Time ($V_{CC} = 10 \text{ V}, I_C = 0.5 \text{ A}, I_{B1} = 25 \text{ mA}, I_{B2} = -25 \text{ mA}$)	t _s		700		ns
Fall Time ($V_{CC} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, I_{B1} = 25 \text{ mA}, I_{B2} = -25 \text{ mA}$)	t _f		80		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%

TYPICAL CHARACTERISTICS



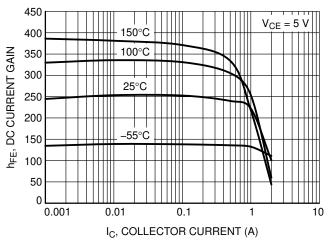
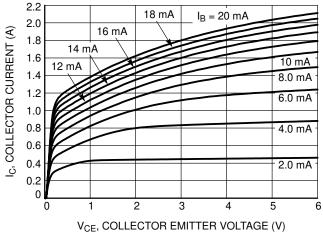


Figure 2. DC Current Gain



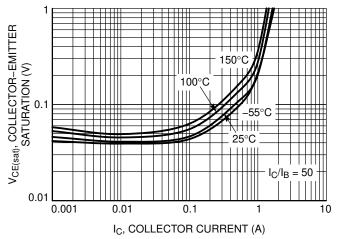
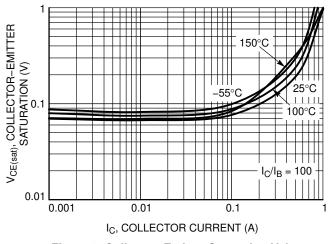


Figure 3. Collector Current as a Function of Collector Emitter Voltage

Figure 4. Collector-Emitter Saturation Voltage



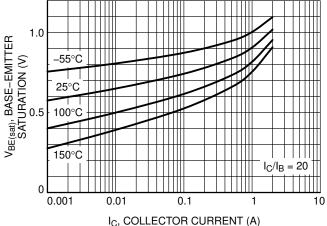
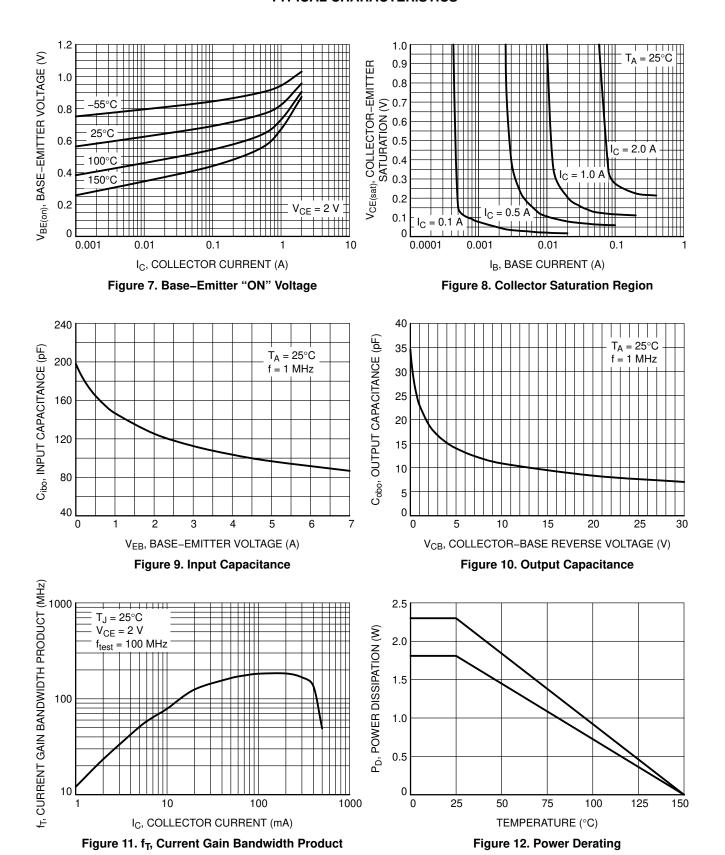


Figure 5. Collector-Emitter Saturation Voltage

Figure 6. Base-Emitter Saturation Voltage

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

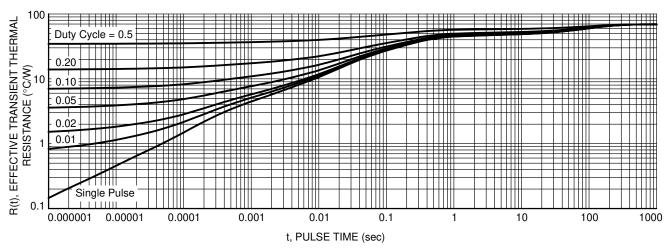


Figure 13. Thermal Resistance by Transistor

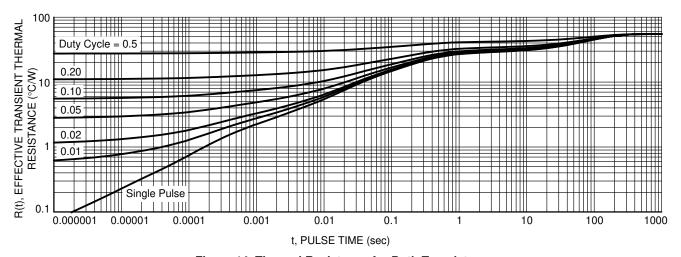
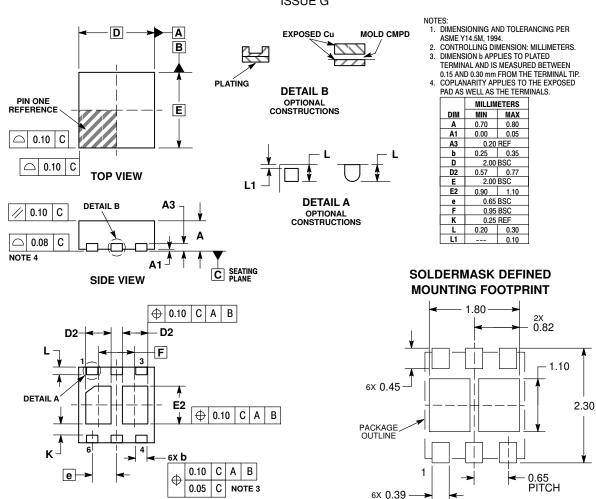


Figure 14. Thermal Resistance for Both Transistors

PACKAGE DIMENSIONS

WDFN6 2x2, 0.65P CASE 506AN **ISSUE G**



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